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The **QT2225** is a dual-port fully integrated 9.95-10.52 Gbps transceiver with adaptive Electronic Dispersion Compensation (EDC). The device provides a high performance interface between a MAC or switch device and copper media including Direct Attach cable and 10GBASE-KR backplanes. The data rate is switchable to 1.25 Gbps, allowing dual 1000BASE-KX / 10GBASE-KR support on a single backplane.

### Description

It can also interface to optical media including SFP+, SFP and XFP modules. When designing for SFP+ applications, customers can generate one dual-rate design that supports SFP+ modules (10GBASE-R) and SFP modules (1000BASE-X), as well as Twainx cable, providing maximum medium flexibility.

In the receive direction the device uses a sophisticated EDC engine that continuously adapts itself to the channel characteristics providing an optimum level of performance regardless of environmental conditions. The QT2225-1 was designed to exceed the performance specified in the 10GBASE-LRM Standard.

In the transmit direction, the 10Gbps driver utilizes signal equalization to compensate for degradation due to copper traces and connectors in the signal path.

### Applications

**QT2225:**
- Backplane 10GBASE-KR/1000BASE-KX
- Hostboard termination for SFP+/SFP limiting modules including 10GBASE-SR, -LR & 1000BASE-X
- Passive & Active Direct Attach SFP+ cable support
- Hostboard termination for XFP modules including 10GBASE-R & -W protocols

**QT2225-1:**
- Hostboard Termination for SFP+/SFP limiting & linear modules: 10GBASE-LRM, -SR, -LR & 1000BASE-X
- Passive & Active Direct Attach SFP+ cable support
## Characteristics

### Electrical
- **Power supplies**: 1.2 V, 1.8 V
- **Power Dissipation**: 1.5 W Typ (per port)
- **ESD**: 2 kV (HBM) except High-Speed I/Os

### Mechanical
- **Package**: 23 x 23 mm² Flip Chip BGA
- **Ball spacing**: 1.0 mm
- **Environmentally friendly package**: RoHS Compliant Option